



IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicants: Toshihiro TAI et al.

For: Plating resin molded article

Serial No.: 10/586 378

Group: 1794

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The Commissioner of Patents

Alexandria VA 22313-1450

DECLARATION UNDER 37 CFR 1.132

I, Toshihiro TAI, hereby declare as follows:

I am one of the co-inventors of the invention as described and claimed in the above identified patent application.

I have carried out additional tests, Comparative Example 8. Test procedures and results are shown below

A resin molded article was obtained, plated and determined in view of adherence test in the same manner as Example 1 of the instant patent application, except for further blending maleic acid with A-1 and B-1. That is, the thermoplastic resin composition contained:

Components of Comparative Example 8	amount, Mass %
(A) A-1 having water absorption of 1.8 %	60
(B) B-1 having water absorption of 0.07 %	40
Control of ( C)	2
Adhesive strength (kPa)	85

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It is noted from the test results that Example 7 of the instant application, having of adhesive strength of 120, is unexpectedly superior to Comparative Example 8 in view of adhesive strength.

I hereby declare that all statements made herein of any own knowledge are true, and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United State Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Dated: November 9, 2010

Toshihiro Tai

Toshihiro TAI